TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHC9151P,TC74VHC9151FT,TC74VHC9151FK TC74VHC9152P,TC74VHC9152FT,TC74VHC9152FK

TC74VHC9151P/FT/FK 9-Bit Schmitt Buffer TC74VHC9152P/FT/FK 9-Bit Schmitt Inverter

The TC74VHC9151/9152 are an ultra-high-speed 9-bit Schmitt Buffer / Inverter fabricated using silicon-gate CMOS technology. The TC74VHC9151/9152 combines low power consumption of CMOS with Schottky TTL speeds.

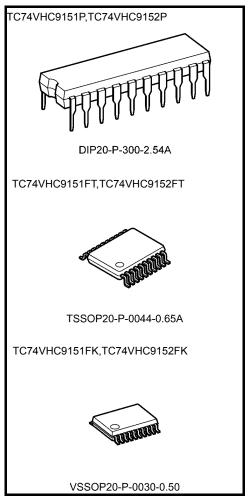
TC74VHC9151 output is a non-inverting type and the TC74VHC9152 output is an inverting type.

All the inputs have hysteresis between the positive-going and negative-going thresholds. Thus the TC74VHC9151/9152 are capable of squaring up transitions of slowly changing input signals and provides an improved noise immunity.

Additionally, all the inputs have a newly developed protection circuit without a diode returned to $V_{\rm CC}$. This enables the inputs to be tolerant of up to 5 volts even when power supply is down. The input power-down protection capability makes the TC74VHC9151/9152 ideal for a wide range of applications, such as interfacing between different voltages, voltage translation from 5 V to 3 V and battery back-up circuits.

Features

- High speed: $t_{pd} = 3.6 \text{ ns (typ.)} (V_{CC} = 5 \text{ V})$
- Low supply current: $I_{CC} = 4 \mu A \text{ (max) (Ta} = 25 \text{°C)}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- All inputs are provided with power-down protection.
- Symmetrical rise and fall delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: $V_{CC \text{ (opr)}} = 2 \text{ to } 5.5 \text{ V}$

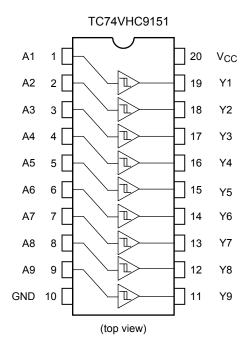


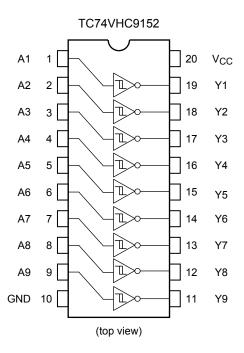
Weight

DIP20-P-300-2.54A : 1.30 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)



Pin Assignment





Truth Table

А	Υ					
	TC74VHC9151	TC74VHC9152				
L	L	Н				
Н	Н	L				

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Absolute Maximum Ratings (Note1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	−0.5 to 7.0	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	lıĸ	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180(TSSOP/VSSOP)	mW
Storage temperature	T _{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2.0 to 5.5	V
Input voltage	V _{IN}	0 to 5.5	٧
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	−40 to 85	°C

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



Electrical Characteristics

DC Characteristics

Ob a manta minting	Cumbal	Test Condition			Ta = 25°C			Ta = −40~85°C		Unit
Characteristics Symbol				V _{CC} (V)	Min	Тур	Max	Min	Max	Offic
					_	_	2.20	_	2.20	
Positive threshold voltage	V_{P}		_	4.5	_	_	3.15	_	3.15	V
				5.5		_	3.85	_	3.85	
		_		3.0	0.90	_	_	0.90	_	
Negative threshold voltage	V_{N}			4.5	1.35	_	_	1.35	_	V
				5.5	1.65	_	_	1.65	_	
		_		3.0	0.30	_	1.20	0.30	1.20	
Hysteresis voltage	V_{H}			4.5	0.40	_	1.40	0.40	1.40	٧
				5.5	0.50	_	1.60	0.50	1.60	
		V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	2.0	_	1.9	_	V
				3.0	2.9	3.0	_	2.9	_	
High-level output voltage	V_{OH}			4.5	4.4	4.5	_	4.4	_	
			I _{OH} = -4 mA	3.0	2.58	_	_	2.48	_	
			I _{OH} = -8 mA	4.5	3.94	_	_	3.80	_	
		V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.0	0.1	_	0.1	٧
Low-level output voltage				3.0	_	0.0	0.1	_	0.1	
	V_{OL}			4.5		0.0	0.1	_	0.1	
			I _{OL} = 4 mA	3.0	_	_	0.36	_	0.44	
			I _{OL} = 8 mA	4.5	_	_	0.36	_	0.44	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	1	_	±0.1	_	±1.0	μΑ
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	-	_	4.0	_	40.0	μΑ



AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics S	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
	,		V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	
		-	3.3 ± 0.3	15	_	4.8	9.4	1.0	10.7	- ns
Propagation delay time	t_{pLH}			50	_	8.1	16.1	1.0	18.4	
(TC74VHC9151)	t_{pHL}		5.0 ± 0.5	15	_	3.3	6.0	1.0	6.8	
				50	_	5.7	10.5	1.0	11.9	
	time ^I pLH	_	3.3 ± 0.3	15	_	4.8	9.3	1.0	10.6	- ns
Propagation delay time				50	_	7.8	15.4	1.0	17.6	
(TC74VHC9152)			5.0 ± 0.5	15	_	3.6	6.3	1.0	7.1	
				50	_	5.7	10.2	1.0	11.6	
Output to output skew	t _{osHL}	(Note 1)	3.3 ± 0.3	50	_	_	1.5	_	1.5	ns
	t _{osLH}		5.0 ± 0.5	50	_	_	1.0	_	1.0	113
Input capacitance	C _{IN}					4	10	_	10	pF
Power dissipation capacitance (Note 2)		TC74VHC9151 (f _{IN} = 1 MHz)		_	11	_	_	_	nE	
	C_{PD}	TC74VHC9152	C74VHC9152 (f _{IN} = 1 MHz)		_	10	_	_	_	pF

Note 1: Parameter guaranteed by design.

 $t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|$

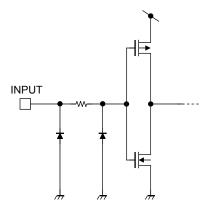
Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 9 \text{ (per bit)}$



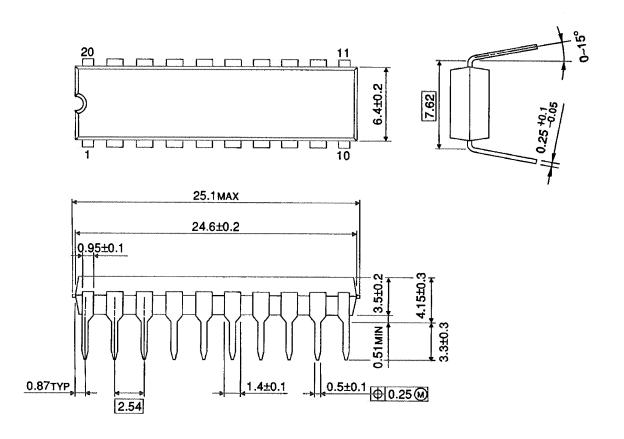
Input Equivalent Circuit



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Package Dimensions

DIP20-P-300-2.54A Unit: mm

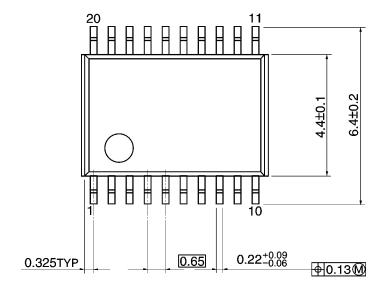


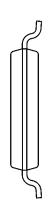
Weight: 1.30 g (typ.)

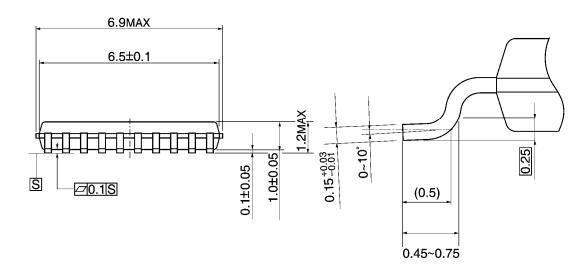
Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm





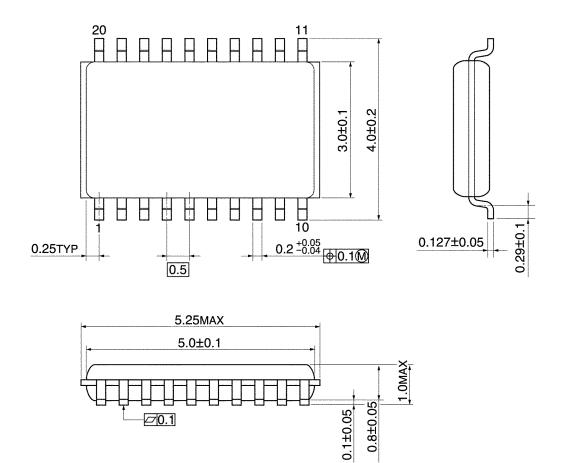


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Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



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Weight: 0.03 g (typ.)



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